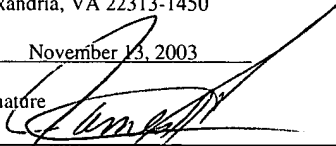


IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Chang-Feng Wan )  
Serial No.: TBD )  
Filed: November 13, 2003 )  
Group No.  
Examiner: N/A

For: **SYSTEM AND METHOD OF FABRICATING MICRO CAVITIES**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

I hereby certify that this correspondence is being deposited with the United States Postal Service as <del>first class</del> <b>Express</b> mail in an envelope addressed to:  Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450  on <u>November 13, 2003</u>  Signature 
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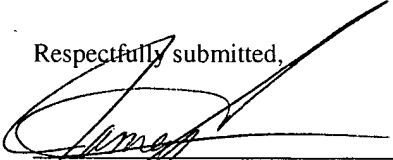
Dear Sir:

**INFORMATION DISCLOSURE STATEMENT**

Herewith are Form PTO-1449 and one copy of each document listed thereon (except for patent applications). Attention is also directed to any item(s) designated below:

- \_\_\_\_\_ 1. A check is enclosed to cover the fee set forth in 37 CFR 1.17(p). Any additional fee required by this paper may be charged to Deposit Account No. 502697.
- \_\_\_\_\_ 2. The undersigned certifies that each enclosed document was cited in a communication from a foreign patent office in a counterpart foreign application not more than three (3) months prior to the filing of the Information Disclosure Statement.
- \_\_\_\_\_ 3. The relevance of any enclosed non-English language document(s) is concisely explained as follows.

Respectfully submitted,

  
James S. Finn  
Reg. No. 38,450

1718 M. Street NW #294  
Washington, DC 20036  
202-607-4607

<b>Form PTO-1449 Modified</b>  <b>List of Patents and Publications Cited by Applicant</b> (Use several sheets if necessary)  <b>U.S. Patent Department of Commerce Patent and Trademark Office</b>	<b>Docket No.:</b> JSF02-0004	<b>Serial No.:</b>
	<b>Applicant:</b> Chang-Feng Wan	
	<b>Filing Date:</b> November 13, 2003	<b>Group:</b>

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	C-1	. J. Yao et al. IEEE J. MEMS Vol. 8(2), 1999, pp. 129-134				
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	<b>Applicant:</b> Chang-Feng Wan					
	<b>Filing Date:</b> November 13, 2003		<b>Group:</b>			
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<b>Date Examined:</b>		<b>Examiner:</b>				

<b>Form PTO-1449 Modified</b>  <b>List of Patents and Publications Cited by Applicant (Use several sheets if necessary)</b>  <b>U.S. Patent Department of Commerce Patent and Trademark Office</b>	<b>Docket No.:</b> JSF02-0004		<b>Serial No.:</b>			
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<b>U.S. PATENT DOCUMENTS</b>						
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<b>Date Examined:</b>		<b>Examiner:</b>				